

**DECLARATION AND POWER OF ATTORNEY - USA PATENT APPLICATION**

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled POSITIVE RESIST COMPOSITION, RESIST LAMINATES AND PROCESS FOR FORMING RESIST PATTERNS  
the specification of which:

- (a) ☐ is attached hereto; or
- (b) ☐ was filed on \_\_\_\_\_ as Application No. 0 / \_\_\_\_\_ or Express Mail No., as Application No. not yet known \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable); or
- (c) ☒ was described and claimed in PCT International Application No. PCT/JP2004/008282 filed on June 8, 2004 and as amended under PCT Article 19 on \_\_\_\_\_ (if any) and/or under PCT Article 34 on \_\_\_\_\_ (if any).

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above;

I acknowledge the duty to disclose information which is material to the patentability of this application in accordance with Title 37, Code of Federal Regulations, § 1.56;

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) listed below and have also identified below any foreign application(s) for patent, design or inventor's certificate or any PCT international application(s) designating at least one country other than the United States of America filed for the same subject matter having a filing date before that of the application(s) of which priority is claimed:

**PRIOR FOREIGN APPLICATION(S)**

COUNTRY (OR INDICATE IF PCT)	APPLICATION NUMBER	DATE OF FILING (day, month, year)	PRIORITY CLAIMED UNDER 37 U.S.C. § 119	
Japan	P2003-166391	11/06/2003	<input checked="" type="checkbox"/> YES	<input type="checkbox"/> NO
Japan	P2003-168130	12/06/2003	<input checked="" type="checkbox"/> YES	<input type="checkbox"/> NO
Japan	P2004-112511	06/04/2004	<input checked="" type="checkbox"/> YES	<input type="checkbox"/> NO
Japan	P2004-112512	06/04/2004	<input checked="" type="checkbox"/> YES	<input type="checkbox"/> NO
			<input type="checkbox"/> YES	<input type="checkbox"/> NO

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed below, and insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the duty to disclose to the U.S. Patent and Trademark Office all information known to me to be material to patentability as defined in Title 37, Code of Federal Regulations, § 1.56, which became available between the filing date of the prior application and the national or PCT international filing date of this application:

**Prior U.S.A. Application(s)**

Application No.: \_\_\_\_\_ Filing Date: \_\_\_\_\_ Status: \_\_\_\_\_

POWER OF ATTORNEY: I hereby appoint the registrants of Knobbe, Martens, Olson & Bear, LLP, 2040 Main Street, Fourteenth Floor, Irvine, California 92614, Telephone (949) 760-0404, Customer No. 20,995.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful, false statements may jeopardize the validity of the application or any patent issued thereon.

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Full name of sole or first inventor: Koki TAMURA

Inventor's signature Koki Tamura Day 27th Month December Year 2005

Residence (city and country): Kawasaki-shi, Japan

Citizenship: Japan

Post Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi,  
Kanagawa-ken, Japan

Full name of second inventor: Daisuke KAWANA

Inventor's signature Daisuke Kawana Day 27th Month December Year 2005

Residence (city and country): Kawasaki-shi, Japan

Citizenship: Japan

Post Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi,  
Kanagawa-ken, Japan

Full name of third inventor: Tomotaka YAMADA

Inventor's signature Tomotaka Yamada Day 27th Month December Year 2005

Residence (city and country): Kawasaki-shi, Japan

Citizenship: Japan

Post Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi,  
Kanagawa-ken, Japan

Full name of forth inventor: Takayuki HOSONO

Inventor's signature Takayuki Hosono Day 27th Month December Year 2005

Residence (city and country): Kawasaki-shi, Japan

Citizenship: Japan

Post Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi,  
Kanagawa-ken, Japan

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Attorney's Docket No. SHGA 037ARFull name of fifth inventor: Taku HIRAYAMAInventor's signature Taku Hirayama Day 27th Month December Year 2005Residence (city and country): Kawasaki-shi, JapanCitizenship: JapanPost Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, JapanFull name of sixth inventor: Kazufumi SATOInventor's signature Kazufumi Sato Day 27th Month December Year 2005Residence (city and country): Kawasaki-shi, JapanCitizenship: JapanPost Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, JapanFull name of seventh inventor: Hiroshi SHIMBORIInventor's signature Hiroshi Shimbori Day 27th Month December Year 2005Residence (city and country): Kawasaki-shi, JapanCitizenship: JapanPost Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, JapanFull name of eighth inventor: Tomoyuki ANDOInventor's signature T. Ando Day 27th Month December Year 2005Residence (city and country): Kawasaki-shi, JapanCitizenship: JapanPost Office Address: c/o TOKYO OHKA KOGYO CO., LTD., 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, Japan

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05F18940 誤謄証 (1/2)

PATENT

ASSIGNMENT

WHEREAS, I/WE (1) Koki TAMURA  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(2) Daisuke KAWANA  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(3) Tomotaka YAMADA  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(4) Takayuki HOSONO  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(5) Taku HIRAYAMA  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(6) Kazufumi SATO  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(7) Hiroshi SHIMBORI  
a Japanese citizen, residing at Kawasaki-shi, Japan  
(8) Tomoyuki ANDO  
a Japanese citizen, residing at Kawasaki-shi, Japan

hereinafter referred to as Assignor (collectively if more than one inventor is listed above), have invented certain new and useful improvements in POSITIVE RESIST COMPOSITION, RESIST LAMINATES AND PROCESS FOR FORMING RESIST PATTERNS, the specification of which:

- (a) ☐ was executed on even date herewith;
- (b) ☐ was filed on \_\_\_\_\_ as ☐ Application No. 0 / \_\_\_\_\_ or ☐ Express Mail No., as Application No. not yet known \_\_\_\_\_ and was amended on \_\_\_\_\_ (if applicable); or
- (c) ☒ was described and claimed in PCT International Application No. PCT/JP2004/008282 filed on June 8, 2004 and as amended under PCT Article 19 on \_\_\_\_\_ (if any) and/or under PCT Article 34 on \_\_\_\_\_ (if any).

AND WHEREAS, TOKYO OHKA KOGYO CO., LTD. with its principal place of business at 150, Nakamaruko, Nakahara-ku, Kawasaki-shi, Kanagawa-ken, Japan, (hereinafter referred to as Assignee) desires to acquire the entire right, title, and interest in and to the said improvements with respect to the United States of America, its territories and possessions.

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, Assignor hereby acknowledges that it has sold, assigned, transferred and set over, and by these presents does hereby sell, assign, transfer and set over, unto Assignee, its successors, legal representatives and assigns, the entire right, title, and interest in the United States of America, and its territories and possessions in, to and under said improvements, and any Patent Applications in the United States of America and all divisions, renewals and continuations thereof, and all Patents of the United States of America which may be granted thereon and all reissues and extensions thereof, and all rights of priority under International Conventions; and Assignor hereby authorizes and requests the Commissioner of Patents of the United States of America to issue all Patents for said improvements to Assignee, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND ASSIGNOR HEREBY covenants and agrees that it will communicate to Assignee, its successors, legal representatives and assigns, any facts known to it respecting said improvements, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said improvements in the United States of America.

IN TESTIMONY WHEREOF, Assignor intending to be legally bound has hereunto affixed its signature.

This 27th day of December, 2005

Koki Tamura  
Signature of Koki TAMURA

This 27th day of December, 2005

Daisuke Kawana  
Signature of Daisuke KAWANA

This 27th day of December, 2005

Tomotaka Yamada  
Signature of Tomotaka YAMADA

This 27th day of December, 2005

Takayuki Hosono  
Signature of Takayuki HOSONO

This 27th day of December, 2005

2005.10.27 T.H  
Taku Hirayama  
Signature of Taku HIRAYAMA

This 27th day of December, 2005

Kazufumi Sato  
Signature of Kazufumi SATO

This 27th day of December, 2005

Hiroshi Shimbori  
Signature of Hiroshi SHIMBORI

This 27th day of December, 2005

2005.11.15 H.S  
Hiroshi Shimbori T. Ando  
Signature of Tomoyuki ANDO

Witnessed by:

Shimohira Mataatomi

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